APPLICATION DATA SHEET

Electronic Version v14

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Title of Invention

[SEMICONDUCTOR STRUCTURE AND FABRICATION THEREFOR]

Application Type : regular, utility
Attorney Docket Number : 13302-US-PA

Correspondence address:

Customer Number: 31561

Inventors Information:

Inventor 1:

Applicant Authority Type: Inventor
Citizenship: TW
Name prefix: Mr.
Given Name: Yi-Ching

Family Name: Wu

Residence:

City of Residence: Kaohsiung County

Country of Residence: TW

Address-1 of Mailing Address: No.69-85, Bao-an Rd., Yong-an Township

Address-2 of Mailing Address:

City of Mailing Address: Kaohsiung County

State of Mailing Address:

Postal Code of Mailing Address: 828
Country of Mailing Address: TW

Phone: Fax:

E-mail:

Inventor 2:

Applicant Authority Type: Inventor
Citizenship: TW
Name prefix: Mr.

Given Name: Jiann-Fu
Family Name: Chen

Residence:
City of Residence:
Country of Residence:
TW
Address-1 of Mailing Address:
No. 113, Lane 576, Sec. 1, Guangfu Rd.

Address-2 of Mailing Address:

City of Mailing Address: Hsinchu City

State of Mailing Address:

Postal Code of Mailing Address: 300
Country of Mailing Address: TW

Phone: Fax: E-mail:

Inventor 3:

Applicant Authority Type:InventorCitizenship:TWName prefix:Mr.

Given Name: Chih-Hsiang Family Name: Shiau

Residence:

City of Residence: Hsinchu City

Country of Residence: TW

Address-1 of Mailing Address: No.20, Alley 62, Lane 99, Puding Rd.,

Address-2 of Mailing Address:

City of Mailing Address: Hsinchu City

State of Mailing Address:

Postal Code of Mailing Address: 300
Country of Mailing Address: TW

Phone: Fax: E-mail:

Attorney Information:

practitioner(s) at Customer Number:

31561



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.